

# **RKP406KS**

# Composite Pin Diode for Antenna Switching

REJ03G1461-0100 Rev.1.00 Jul 10, 2006

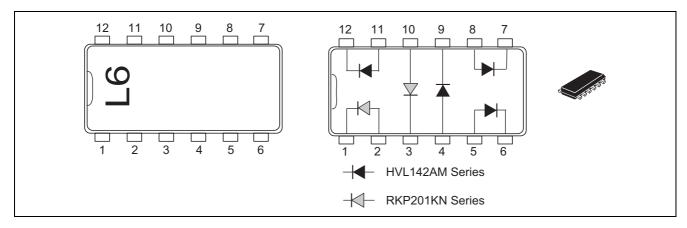
#### **Features**

- An optimal solution for antenna switching in mobile phones.
- Low capacitance. (C = 0.35 pF max)
- Low forward resistance. (rf =  $2.0 \Omega$  max @I<sub>F</sub> = 2 mA, f = 100 MHz)
- Thin outline of diode array with six different kind elements (MFP12) is suitable for surface mount design.

#### **Ordering Information**

Type No.	Laser Mark	Package Name	Package Code	
RKP406KS	L6	MFP12	PUSF0012ZA-A	

#### **Pin Arrangement**



## **Absolute Maximum Ratings**

 $(Ta = 25^{\circ}C)$ 

Item	Symbol	Value	Unit	
Reverse voltage	V <sub>R</sub>	30	V	
Forward current	I <sub>F</sub>	100	mA	
Power dissipation	Pd *	100	mW	
Junction temperature	Тј	125	°C	
Storage temperature	Tstg	−55 to +125	°C	

Note: Per one device

#### **Electrical Characteristics (HVL142AM Series)**

 $(Ta = 25^{\circ}C)$ 

Item	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse current	I <sub>R</sub>	_	_	100	nA	V <sub>R</sub> = 30 V
Forward voltage	V <sub>F</sub>	_	_	1.0	V	I <sub>F</sub> = 10 mA
Capacitance	С	_	_	0.35	pF	$V_R = 1 V, f = 1 MHz$
Forward resistance	r <sub>f</sub>	_	_	1.3	Ω	I <sub>F</sub> = 10 mA, f = 100 MHz
ESD-Capability *1	_	100	_	_	V	$C = 200 \text{ pF}, R = 0 \Omega$ , Both forward
						and reverse direction 1 pulse.

## **Electrical Characteristics (RKP201KN Series)**

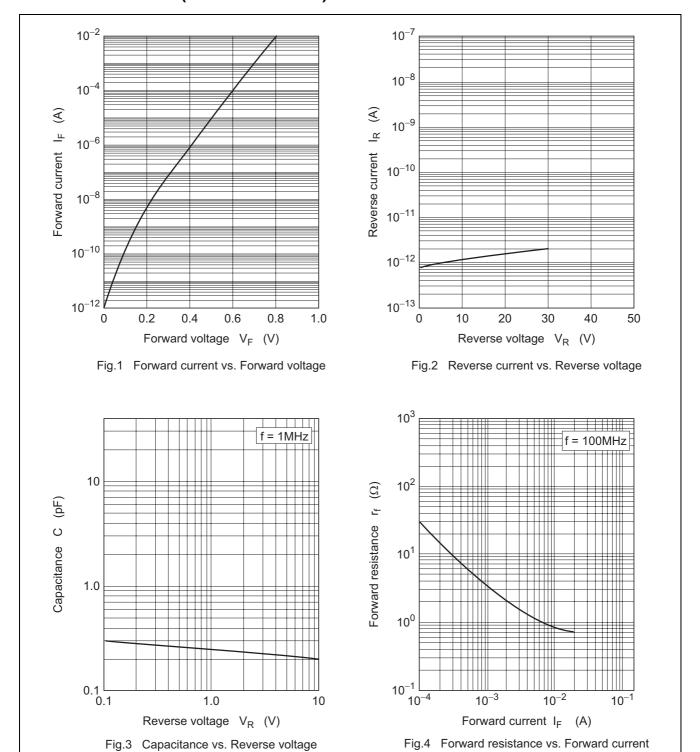
 $(Ta = 25^{\circ}C)$ 

Item	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse current	I <sub>R</sub>	_	_	100	nA	V <sub>R</sub> = 30 V
Forward voltage	V <sub>F</sub>	_	_	0.9	V	$I_F = 2 \text{ mA}$
Capacitance	С	_	_	0.35	pF	V <sub>R</sub> = 1 V, f = 1 MHz
Forward resistance	r <sub>f</sub>	_	_	2.0	Ω	I <sub>F</sub> = 2 mA, f = 100 MHz
ESD-Capability *1	_	100	_	_	V	$C = 200 \text{ pF}, R = 0 \Omega$ , Both forward
						and reverse direction 1 pulse.

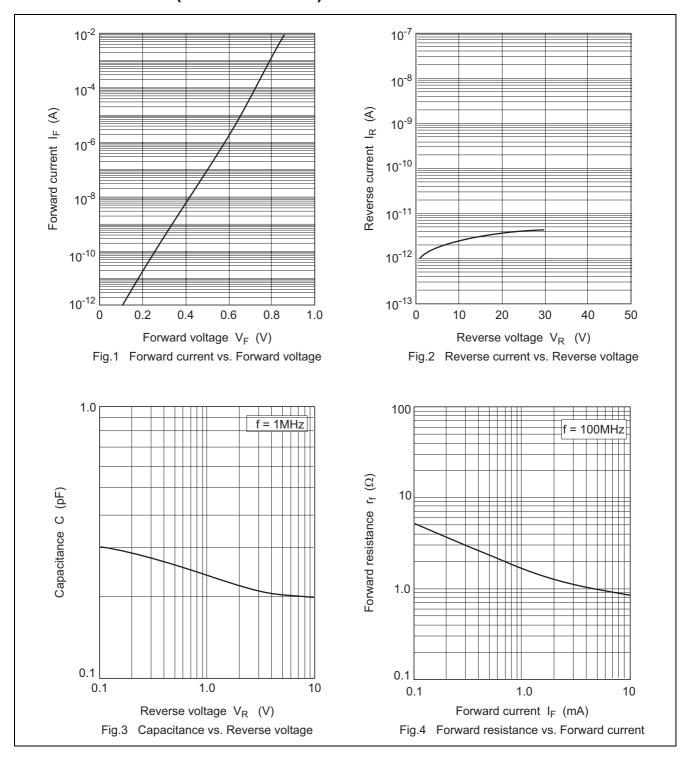
Notes: 1. Failure criterion ;  $I_R > 100 \text{ nA}$  at  $V_R = 30 \text{ V}$ 

2. For MFP12 package, the material of lead is exposed for cutting plane. There for, soldering nature of lead tip part is considered as unquestioned. Please kindly consider soldering nature.

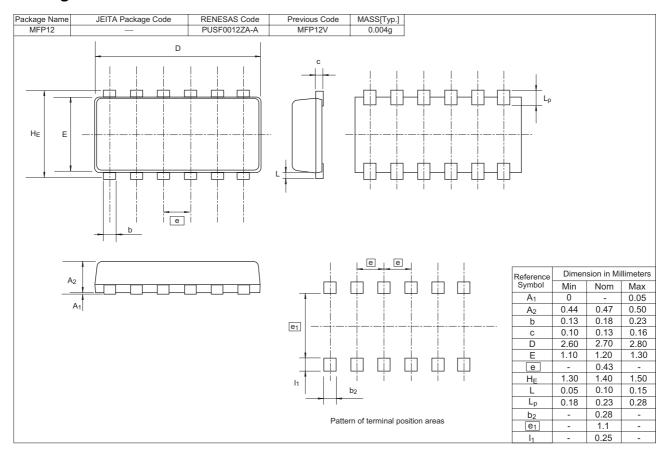
## **Main Characteristic (HVL142AM Series)**



## **Main Characteristic (RKP201KN Series)**



#### **Package Dimensions**



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